

Description

The SX65N06NF uses advanced technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

$V_{DS} = 65V$ $I_D = 65A$

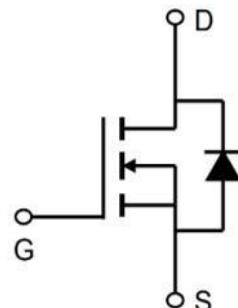
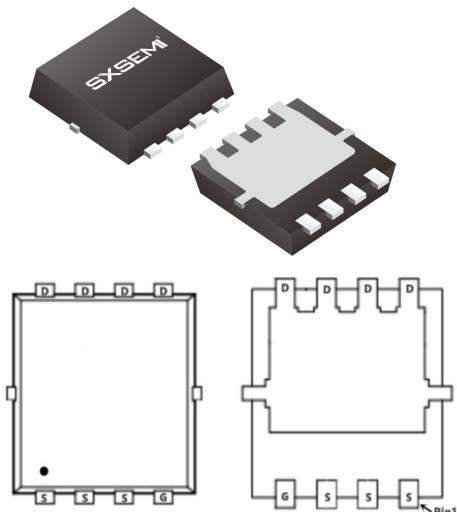
$R_{DS(ON)} < 8.0m\Omega$ @ $V_{GS}=10V$

Application

Battery protection

Load switch

Uninterruptible power supply

PDFN5*6-8L**Absolute Maximum Ratings ($T_c=25^\circ C$ unless otherwise noted)**

Symbol	Parameter	Value	Unit
V_{DS}	Drain source voltage	60	V
V_{GS}	Gate source voltage	± 20	V
$I_D @ T_A=25^\circ C$	Continuous drain current	65	A
$I_D @ T_A=70^\circ C$	Continuous drain current	31	A
I_{DM}	Pulsed drain current	240	A
$P_D @ T_A=25^\circ C$	Power dissipation	33.1	W
EAS	Single pulsed avalanche energy	130	mJ
TSTG	Storage Temperature Range	-55 to 150	°C
T_j	Operation and storage temperature	-55 to 150	°C
$R_{\theta JC}$	Thermal resistance, junction-case	2.1	°C/W
$R_{\theta JA}$	Thermal resistance, junction-ambient5)	25	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V(BR)DSS	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$	65	72	-	V
IGSS	Gate-body Leakage Current	$V_{DS}=0\text{V}$, $V_{GS}=\pm 20\text{V}$	-	-	± 100	nA
IDSS $T_J=25^\circ\text{C}$	Zero Gate Voltage Drain Current	$V_{DS}=65\text{V}$, $V_{GS}=0\text{V}$	1	100	μA	
IDSS $T_J=100^\circ\text{C}$						
VGS(th)	Gate-Threshold Voltage	$V_{DS}=V_{GS}$, $I_D=250\mu\text{A}$	1.2	1.7	2.5	V
RDS(on)	Drain-Source On-Resistance ⁴	$V_{GS}=10\text{V}$, $I_D=20\text{A}$	-	6.5	8.0	$\text{m}\Omega$
RDS(on)	Drain-Source On-Resistance ⁴	$V_{GS}=4.5\text{V}$, $I_D=10\text{A}$		8.5	10	$\text{m}\Omega$
gfs	Forward Transconductance ⁴	$V_{DS} = 10\text{V}$, $I_D = 10\text{A}$	-	45	-	S
Ciss	Input Capacitance	$V_{DS}=30\text{V}$, $V_{GS}=0\text{V}$, $f=1\text{MHz}$	-	1210	-	pF
Coss	Output Capacitance		-	343	-	
Crss	Reverse Transfer Capacitance		-	17	-	
R _g	Gate Resistance	$f=1\text{MHz}$	-	1.5	-	Ω
Q _g	Total Gate Charge	$V_{GS}=10\text{V}$, $V_{DS}=30\text{V}$, $I_D= 10\text{A}$	-	21.7	-	nC
Q _{gs}	Gate-Source Charge		-	3.9	-	
Q _{gd}	Gate-Drain Charge		-	4.5	-	
td(on)	Turn-On Delay Time	$V_{GS}=10\text{V}$, $V_{DD}=30\text{V}$, $R_G= 3\Omega$, $I_D=10\text{A}$	-	7.3	-	ns
t _r	Rise Time		-	8.5	-	
td(off)	Turn-Off Delay Time		-	19.6	-	
t _f	Fall Time		-	5.6	-	
trr	Body Diode Reverse Recovery Time	$I=10\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$	-	34	-	ns
Q _{rr}	Body Diode Reverse Recovery Charge		-	17	-	nC
VSD	Diode Forward Voltage ⁴	$I_S=10\text{A}$, $V_{GS} = 0\text{V}$	-	-	1.2	V
IS	Continuous Source Current	$T_A=25^\circ\text{C}$	-	-	65	A

Note

- 1、The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2、The data tested by pulsed , pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
- 3、The EAS data shows Max. rating . The test condition is $VDD=25\text{V}$, $VGS=10\text{V}$, $L=0.1\text{mH}$, $IAS=38\text{A}$
- 4、The power dissipation is limited by 150°C junction temperature
- 5、The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation

Typical Characteristics

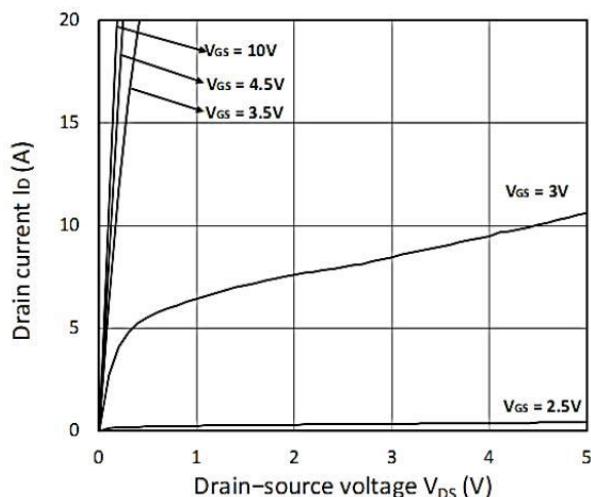


Figure 1. Output Characteristics

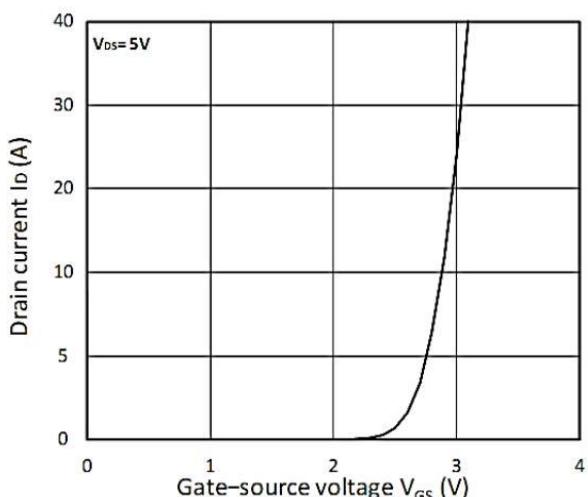


Figure 2. Transfer Characteristics

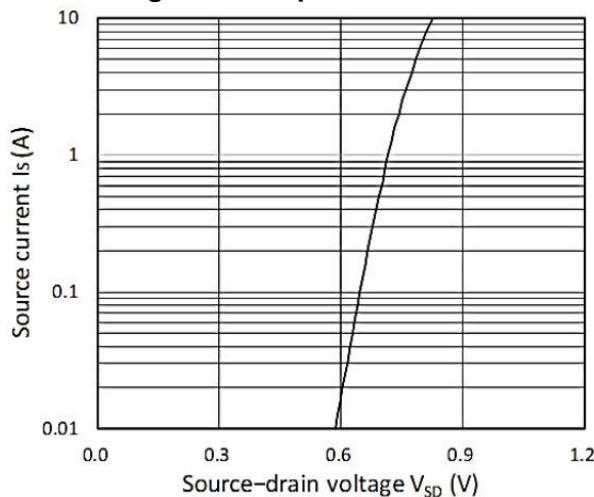


Figure 3. Forward Characteristics of Reverse

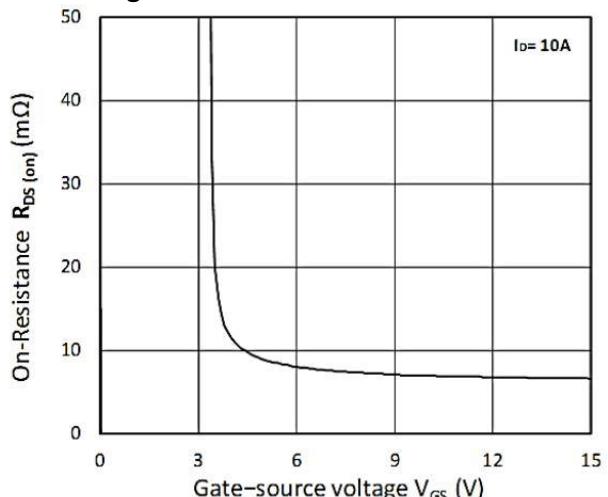


Figure 4. RDS(ON) vs.VGS

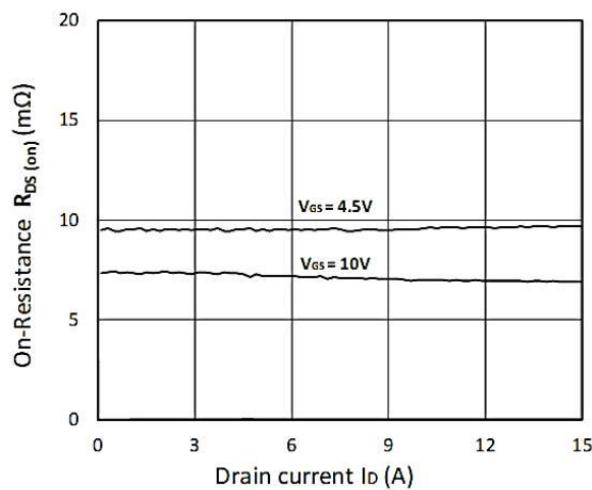


Figure 5. RDS(ON) vs. ID

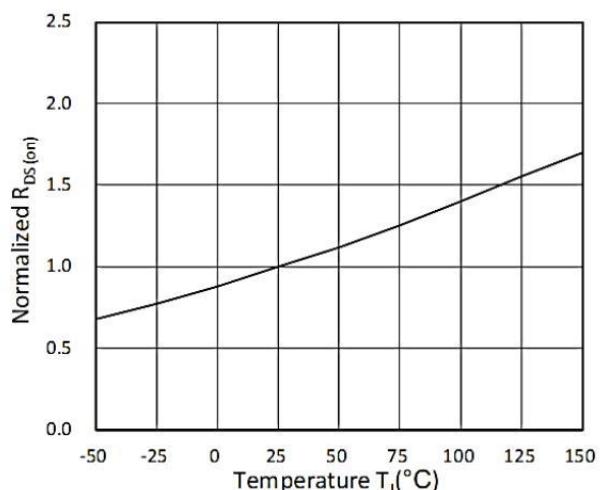


Figure 6. Normalized RDS(on) vs. Temperature

Typical Characteristics

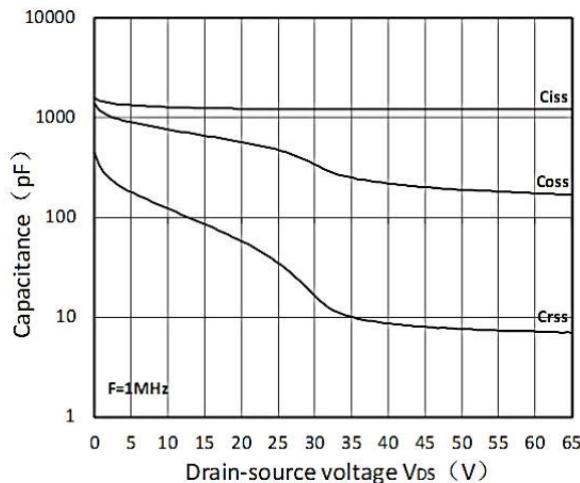


Figure 7. Capacitance Characteristics

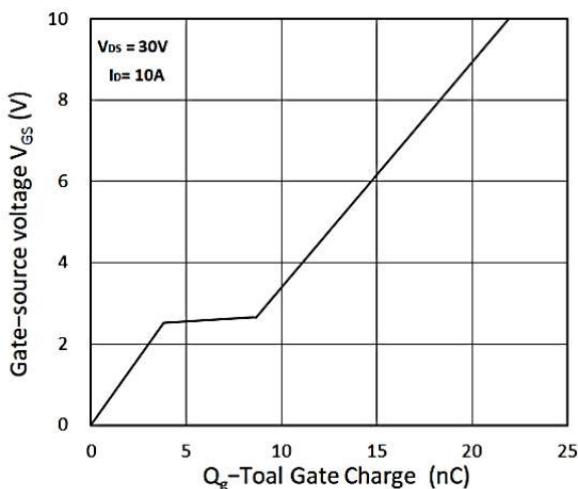


Figure 8. Gate Charge Characteristics

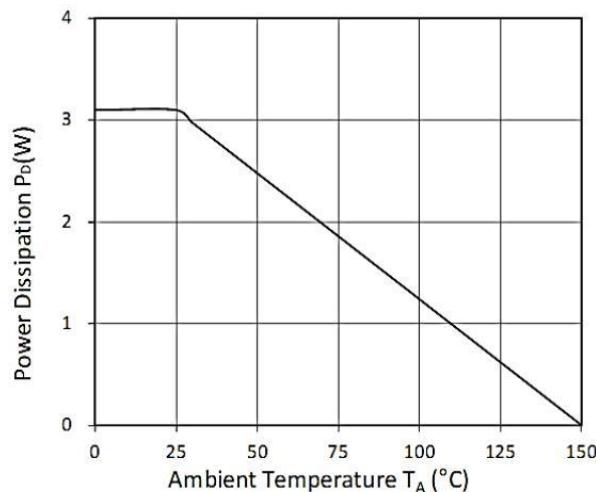


Figure 9. Power Dissipation

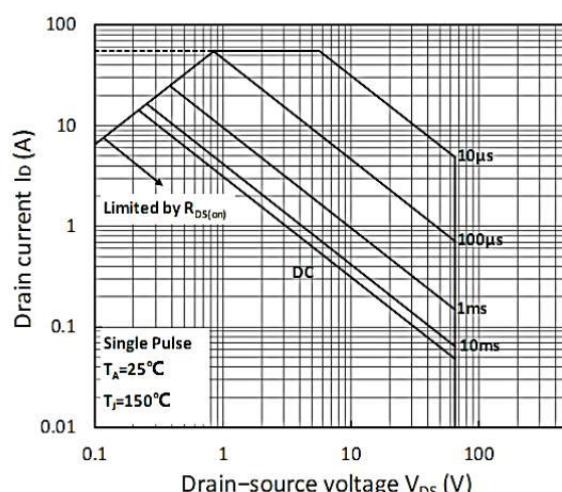


Figure 10. Safe Operating Area

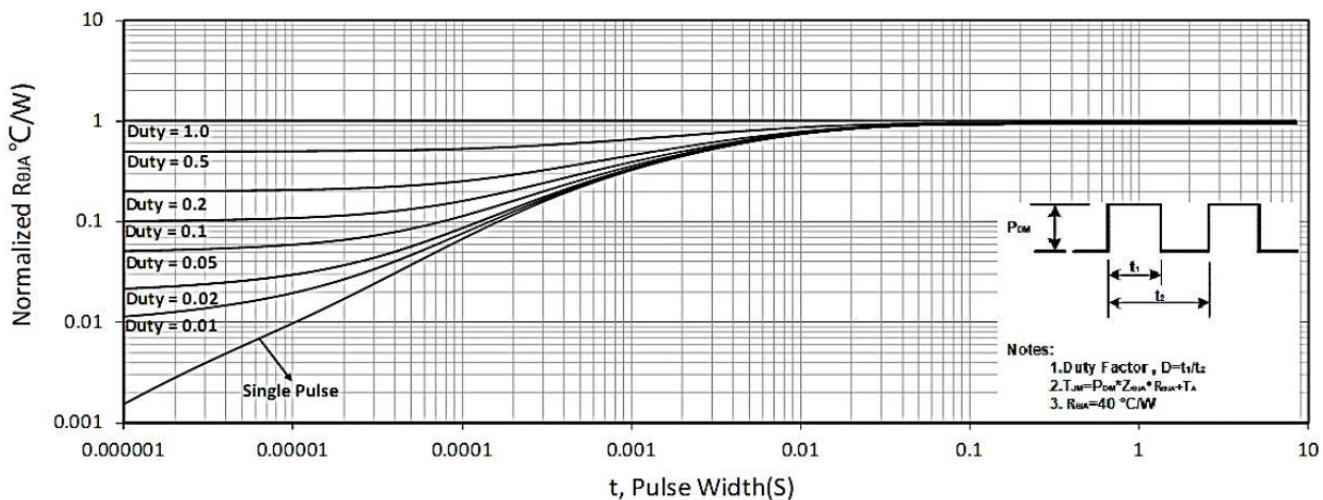
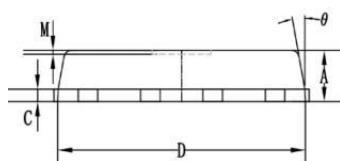
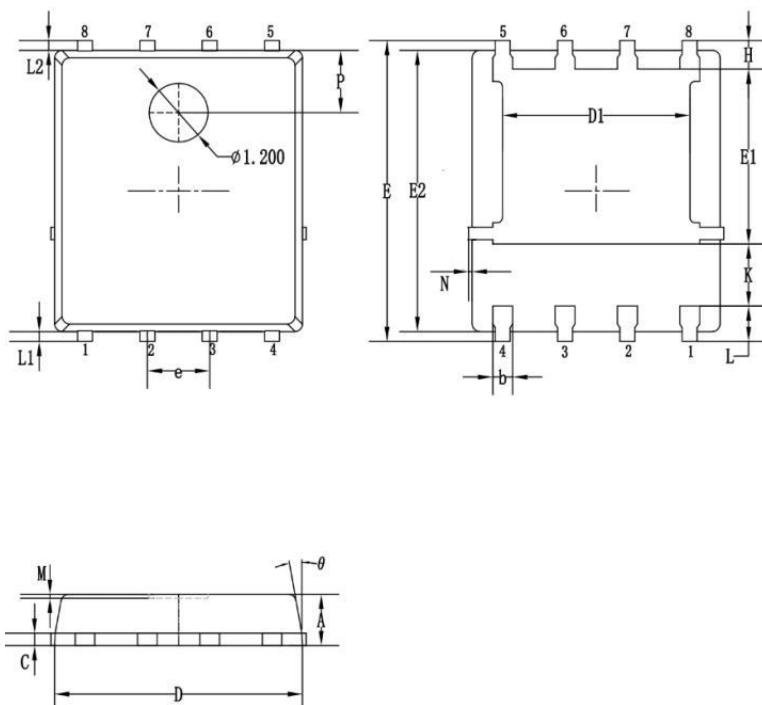


Figure 11. Normalized Maximum Transient Thermal Impedance

Package Mechanical Data-PDFN5*6-8L Single



Symbol	Dim in mm		
	Min	Typ	Max
A	0.9	1.05	1.2
b	0.3	0.4	0.5
C	0.2	0.25	0.35
D	4.9	5.05	5.2
D1	3.72	3.82	4.12
E	5.9	6.1	6.3
E1	3.3	3.5	3.7
E2	5.6	5.75	5.9
e	1.27BSC		
H	0.48	0.58	0.7
K	1.14	1.27	1.4
L	0.54	0.74	0.84
L1/L2	0.1	0.2	0.3
θ	8°	10°	12°
M	0.08REF		
N	0		
P	1.28REF		

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
TAPING	PDFN5*6-8L		5000